

## P-Channel 60V MOSFET

### E060P032CL1

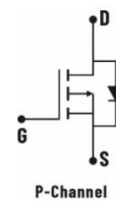
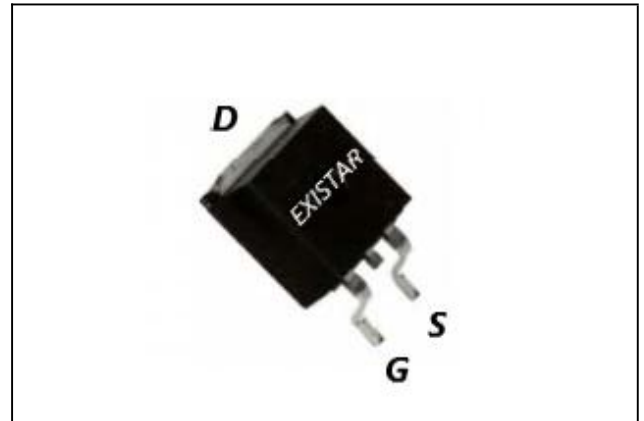
$V_{DS}$ (V)	$R_{DS(on),max}$ (m $\Omega$ )	$I_D$ (A)
-60V	32 @ $V_{GS} = -10V$	-34

### Features

- Low  $R_{DS(on)}$  trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

### Applications

- DC/DC conversion
- Power switch
- PD charger
- Moto driver

**TO-252**


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### Package And Ordering Information

Ordering code	Package	Marking
E060P032CL1	TO-252	E060P032CL1

### Ordering Information

Package	Units/ Reel	Reels/ Inner Box	Units/ Inner Box
TO-252	2500	2	5000

**Key Performance Parameters**

Parameter	Value	Unit
VDS, min @ Tj(max)	-60	V
ID, pulse	-136	A
RDS(ON), max @ VGS=-10V	32	mΩ
Qg	68	nC

**Absolute Maximum Ratings at Tj=25°C Unless Otherwise Noted**

Parameter	Symbol	Limit	Unit
Drain-source voltage	V <sub>DS</sub>	-60	V
Gate-source voltage	V <sub>GS</sub>	±20	
Continuous drain current	I <sub>D</sub>	T <sub>C</sub> =25°C	-34
		T <sub>C</sub> =100°C	-24
Pulsed drain current	I <sub>D,pulse</sub>	-136	A
Avalanche energy, single pulse	E <sub>AS</sub>	196	mJ
Power dissipation	P <sub>D</sub>	T <sub>C</sub> =25°C	79
		T <sub>A</sub> =25°C	-
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 To 175	°C

**Thermal Characteristics**

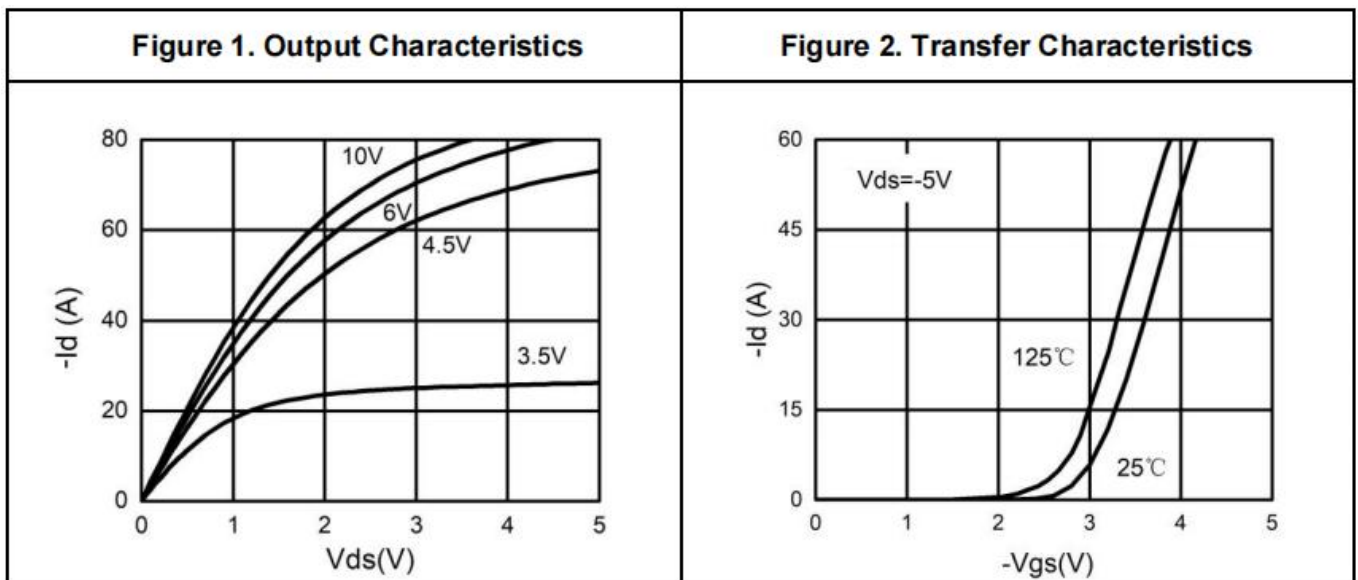
Parameter	Symbol	Max.	Unit
Thermal resistance, junction-to-case	R <sub>θJC</sub>	1.9	°C/W
Thermal resistance, junction-to-ambient	R <sub>θJA</sub>	-	

**Electrical Characteristics at Tj=25°C unless otherwise specified**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
<b>Static</b>						
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	-60			V	V <sub>GS</sub> = 0, I <sub>D</sub> = -250 μA
Gate-source threshold voltage	V <sub>GS(th)</sub>	-1		-2.5	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA
Gate-body leakage	I <sub>GSS</sub>			±100	nA	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V
Zero gate voltage drain current	I <sub>DSS</sub>			-1	μA	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V
Drain-source on-resistance	R <sub>DS(on)</sub>		25	32	mΩ	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -15 A
Drain-source on-resistance	R <sub>DS(on)</sub>		30	35	mΩ	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -10 A
Forward transconductance	g <sub>fs</sub>		30.5		S	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -10 A

Gate resistance	$R_g$				$\Omega$	$f=1\text{MHz}$
<b>Gate Charge</b>						
Total gate charge	$Q_g$		68		nC	$V_{DS} = -30\text{ V}, I_D = -20\text{ A}, V_{GS} = -10\text{ V}$
Gate-source charge	$Q_{gs}$		10.5			
Gate-drain charge	$Q_{gd}$		13			
<b>Dynamic</b>						
Turn-on delay time	$t_{d(on)}$		12.2		ns	$V_{DS} = -30\text{ V}, V_{GS} = -10\text{ V},$ $R_L=1.5\Omega, R_{GEN} = 3\Omega$
Rise time	$t_r$		10			
Turn-off delay time	$t_{d(off)}$		64			
Fall time	$t_f$		14			
Input capacitance	$C_{iss}$		4026		pF	$V_{DS} = -25\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{MHz}$
Output capacitance	$C_{oss}$		134			
Reverse transfer capacitance	$C_{rss}$		98			
<b>Body Diode</b>						
Diode forward voltage	$V_{SD}$			-1.2	V	$V_{GS} = 0\text{ V}, I_S = -15\text{ A}$
Reverse recovery time	$t_{rr}$		26		ns	$I_F = -20\text{ A}, di/dt = -100\text{ A}/\mu\text{s}$
Reverse recovery charge	$Q_{rr}$		29		nC	

### Electrical Characteristics Diagrams



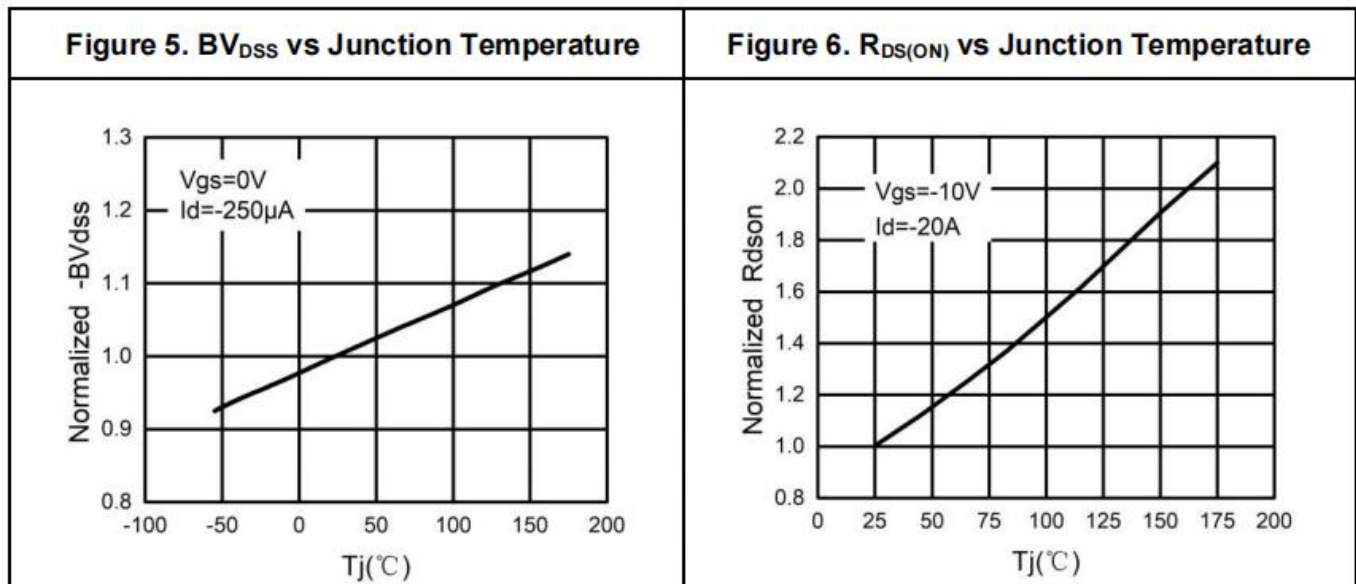
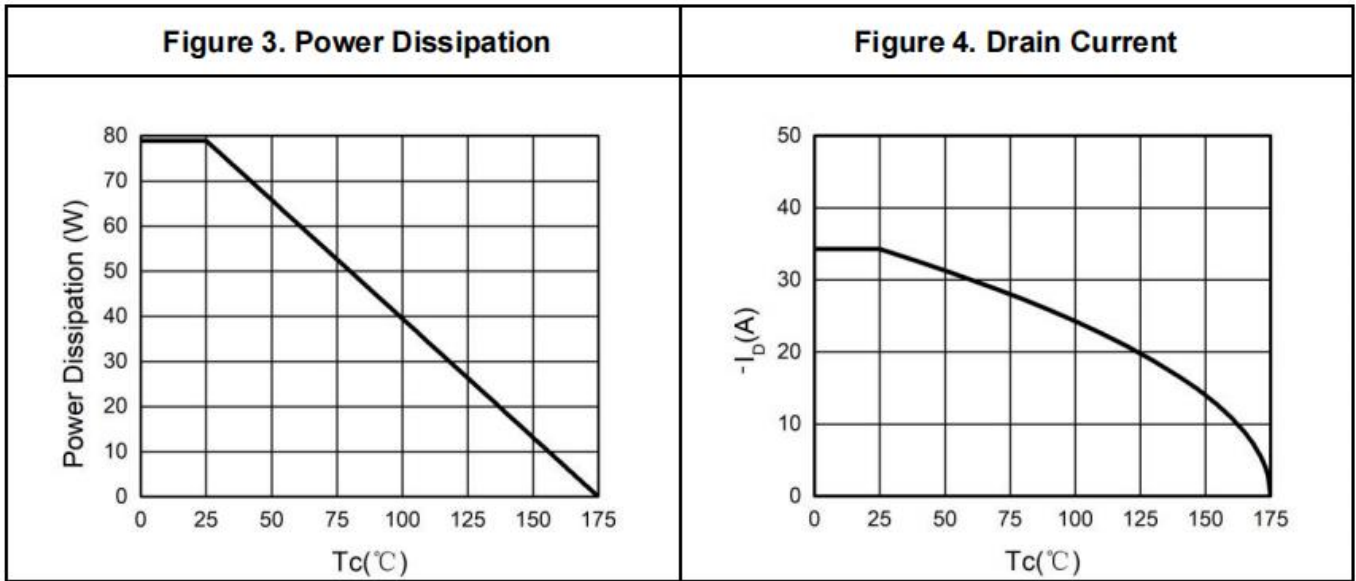


Figure 7. Gate Charge Waveforms

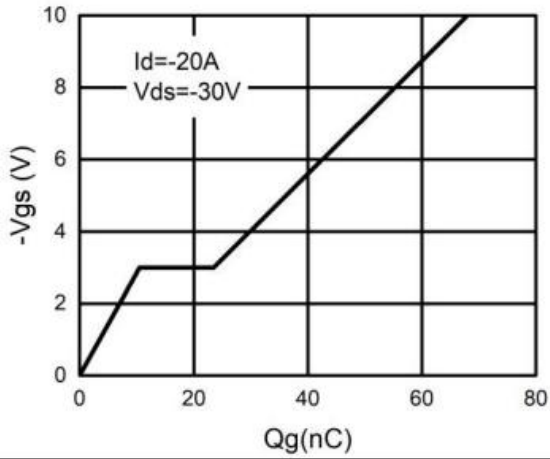


Figure 8. Capacitance

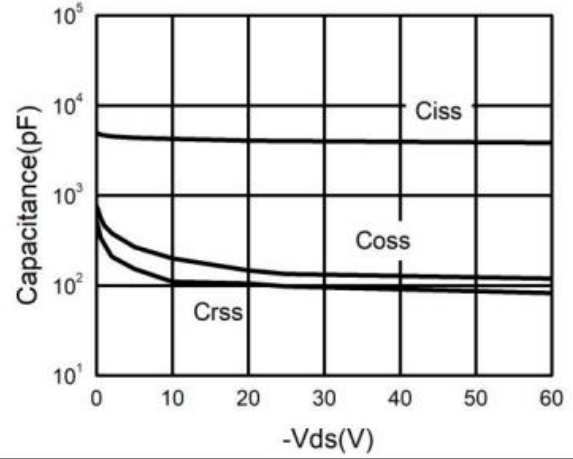


Figure 9. Body-Diode Characteristics

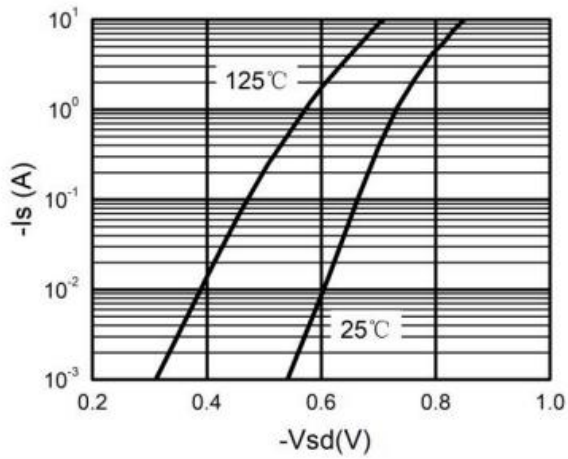
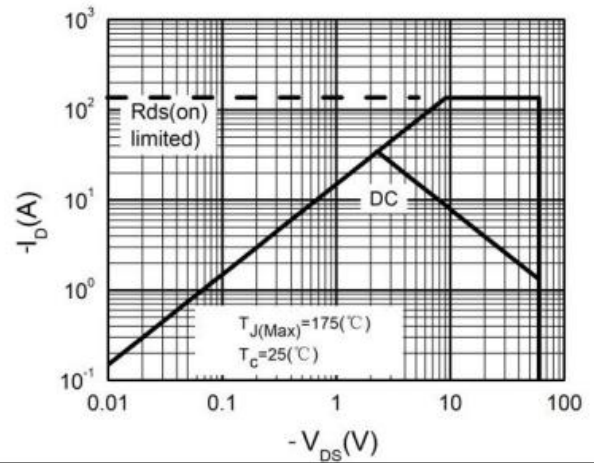
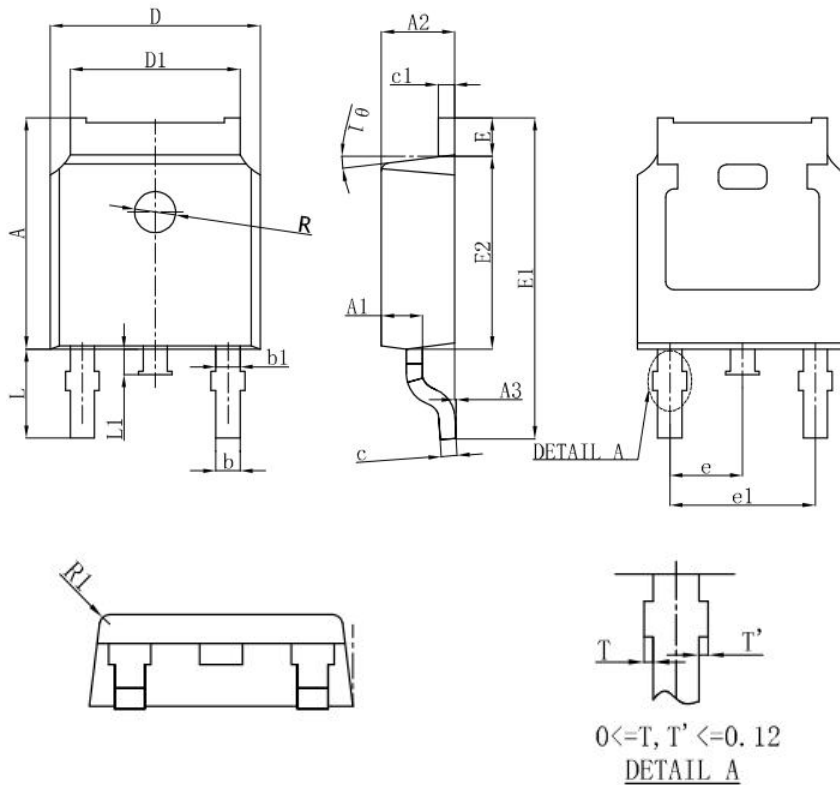


Figure 10. Maximum Safe Operating Area



**Package Outline Dimensions**


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	7.050	7.100	7.150
A1	0.960	1.010	1.060
A2	2.250	2.300	2.350
A3	0.000	0.050	0.100
b	0.760REF.		
b1	1.000REF.		
c	0.508REF.		
c1	0.508REF.		
D	6.550	6.600	6.650
D1	5.220	5.320	5.420
E	0.950	1.000	1.050
E1	9.700	9.900	10.100
E2	6.050	6.100	6.150
e	2.286BSC		
e1	4.572REF.		
L	2.650	2.800	2.950
L1	0.700	0.800	0.900
$\theta$	7° REF.		
R	0.250REF.		

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